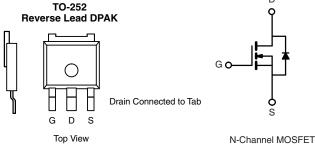


Vishay Siliconix

Automotive N-Channel 30 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY			
V _{DS} (V)	30		
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.0060		
$R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 V$	0.0085		
I _D (A)	50		
Configuration	Single		
	D		



FEATURES

- TrenchFET[®] Power MOSFET
- AEC-Q101 Qualified
- 100 % R_g and UIS Tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



ORDERING INFORMATION

Package	TO-252 Reverse Lead DPAK	
Lead (Pb)-free and Halogen-free	SQR50N03-06P-GE3	

ABSOLUTE MAXIMUM RATINGS	(T _C = 25 °C, unless	s otherwise noted	ł)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V _{GS} ± 20		v	
Continuous Drain Current ^a	T _C = 25 °C	- I _D	50		
	T _C = 125 °C		50		
Continuous Source Current (Diode Conduction) ^a		I _S	50	А	
Pulsed Drain Current ^b		I _{DM}	200		
Single Pulse Avalanche Current		I _{AS}	45		
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	101	mJ	
Maximum Power Dissipation ^b	T _C = 25 °C	D	83	W	
	T _C = 125 °C	P _D	27		
Operating Junction and Storage Temperature F	Range	T _J , T _{stg}	- 55 to + 175	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient	PCB Mount ^c	R _{thJA}	50	°C/W	
Junction-to-Case (Drain)		R _{thJC}	1.8	0/10	

Notes

a. Package limited.

b. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$

c. When mounted on 1" square PCB (FR-4 material).



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PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static				<u> </u>	1	1		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \ \mu\text{A}$		30	-	-		
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	- V _{GS} , I _D = 250 μΑ	1.5	2.0	2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA	
Zero Gate Voltage Drain Current		$V_{GS} = 0 V$	V _{DS} = 30 V	-	-	1		
	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 30 V, T _J = 125 °C	-	-	50	μA	
		$V_{GS} = 0 V$	V _{DS} = 30 V, T _J = 175 °C	-	-	250		
On-State Drain Current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 V$	50	-	-	Α	
		$V_{GS} = 10 V$	I _D = 20 A	-	0.0047	0.0060	Ω	
Ducia Course On Otata Decistore of		V _{GS} = 10 V	I _D = 20 A, T _J = 125 °C	-	-	0.0090		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V	I _D = 20 A, T _J = 175 °C	-	-	0.0107		
		$V_{GS} = 4.5 V$	I _D = 20 A	-	0.0067	0.0085		
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		-	74	-	S	
Dynamic ^b	·	·						
Input Capacitance	C _{iss}		V V _{DS} = 25 V, f = 1 MHz	-	3222	4030	pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$		-	563	705		
Reverse Transfer Capacitance	C _{rss}			-	241	300		
Total Gate Charge ^c	Qg		4.5 V V _{DS} = 15 V, I _D = 50 A	-	25.2	38	nC	
Gate-Source Charge ^c	Q _{gs}	$V_{GS} = 4.5 V$		-	9.1	-		
Gate-Drain Charge ^c	Q _{gd}			-	9.4	-		
Gate Resistance	Rg	f = 1 MHz		0.5	1.6	2.8	Ω	
Turn-On Delay Time ^c	t _{d(on)}			-	10	15		
Rise Time ^c	tr	$\label{eq:V_DD} \begin{array}{l} V_{DD} = 15 \; V, \; R_L = 0.3 \; \Omega \\ I_D \cong 50 \; A, \; V_GEN = 10 \; V, \; R_g = 1 \; \Omega \end{array}$		-	10	15	ns	
Turn-Off Delay Time ^c	t _{d(off)}			-	26	39		
Fall Time ^c	t _f			-	9	14		
Source-Drain Diode Ratings and Char	acteristics ^b							
Pulsed Current ^a	I _{SM}			-	-	200	Α	
	V _{SD}	I _F = 85 A, V _{GS} = 0 V		-	1	1.5	V	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

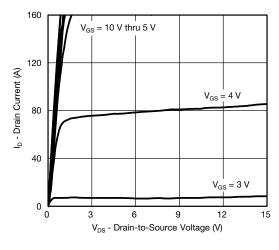
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2

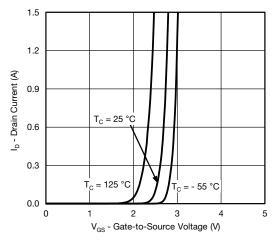


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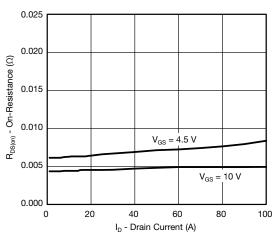
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



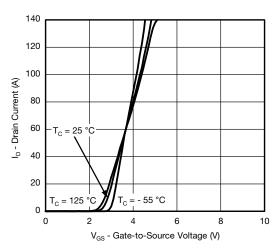
Output Characteristics



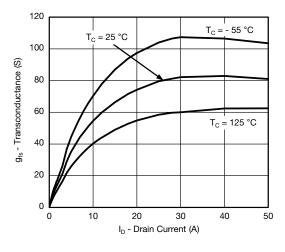
Transfer Characteristics



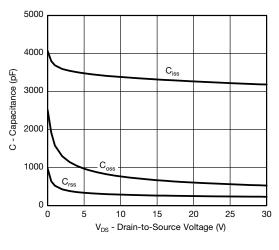
On-Resistance vs. Drain Current



Transfer Characteristics



Transconductance



Capacitance

S12-2198-Rev. C, 24-Sep-12

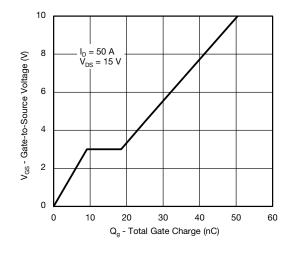
3

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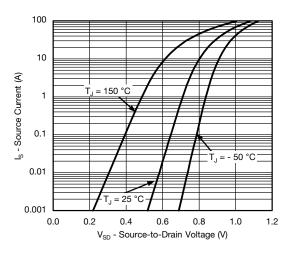


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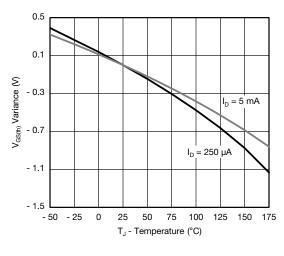
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



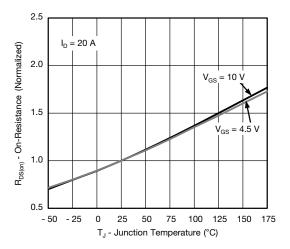
Gate Charge



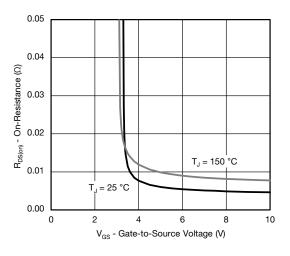
Source Drain Diode Forward Voltage



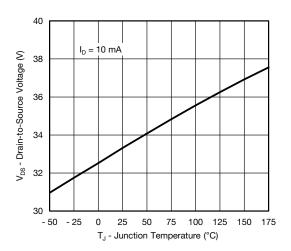
Threshold Voltage



On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage



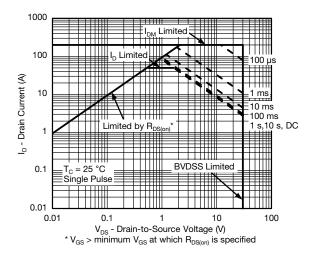
Drain Source Breakdown vs. Junction Temperature

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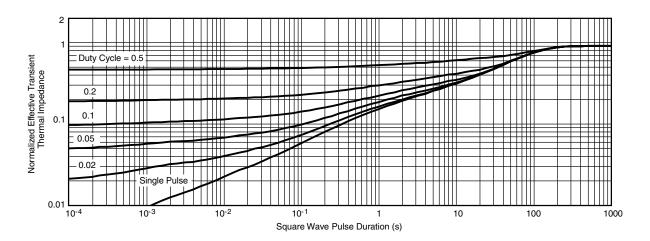


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THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)



Safe Operating Area

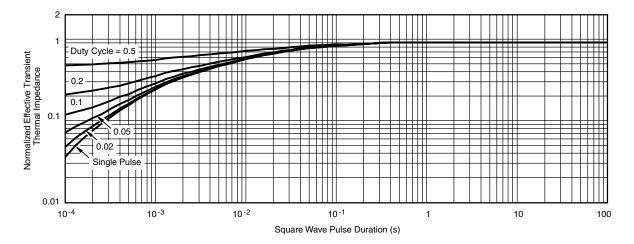


Normalized Thermal Transient Impedance, Junction-to-Ambient



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THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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